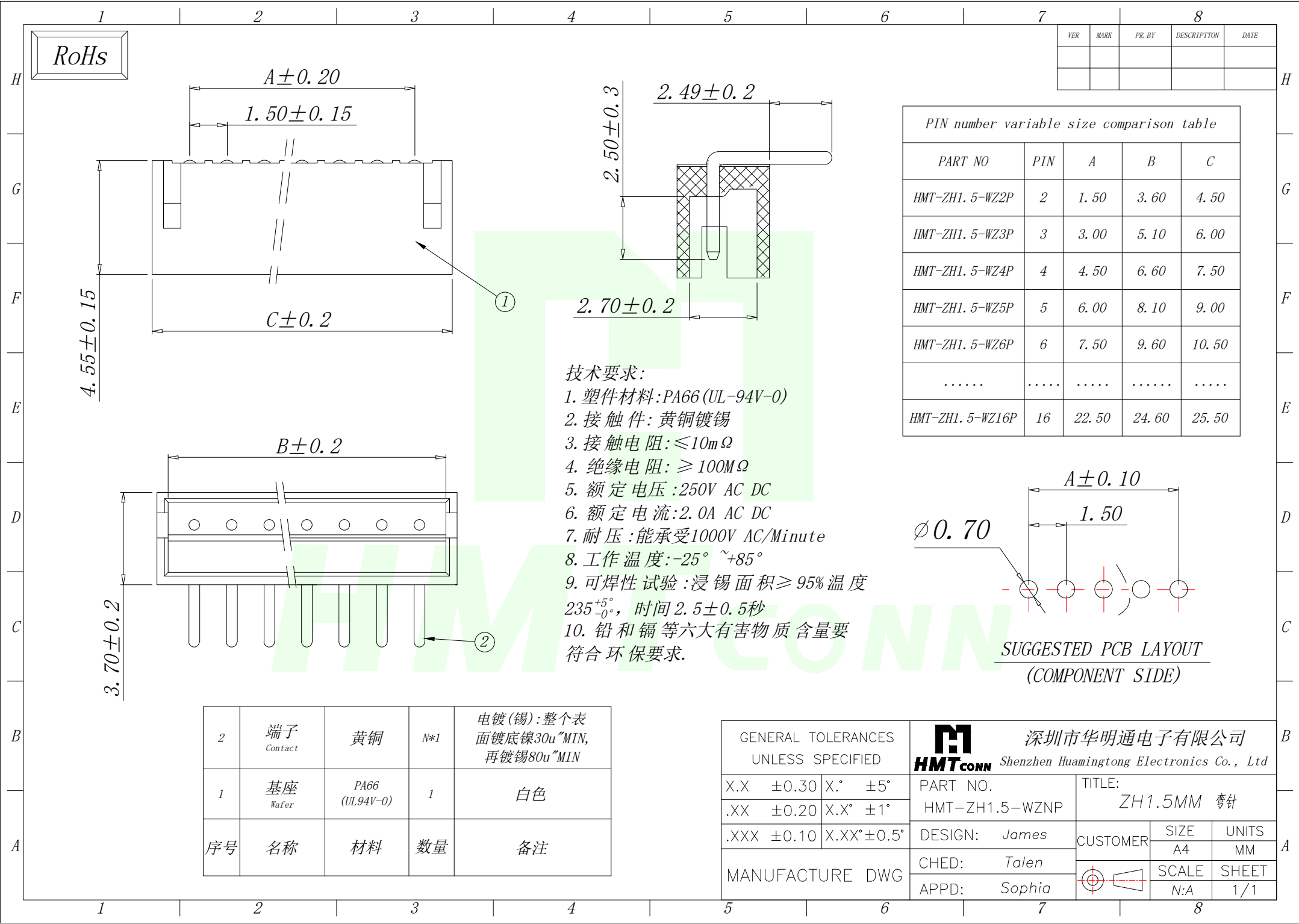
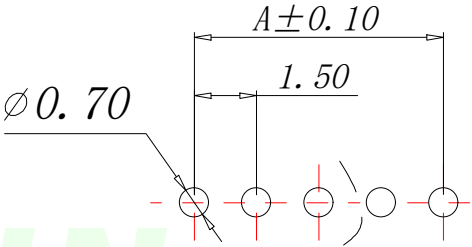




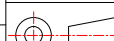
- 技术要求:
1. 塑件材料:PA66 (UL-94V-0)
 2. 接触件:黄铜镀锡
 3. 接触电阻:≤10mΩ
 4. 绝缘电阻:≥100MΩ
 5. 额定电压:250V AC DC
 6. 额定电流:2.0A AC DC
 7. 耐压:能承受1000V AC/Minute
 8. 工作温度:-25° ~+85°
 9. 可焊性试验:浸锡面积≥95%温度235⁺⁵₋₀°, 时间2.5±0.5秒
 10. 铅和镉等六大有害物质含量要符合环保要求.

PIN number variable size comparison table				
PART NO	PIN	A	B	C
HMT-ZH1.5-WZ2P	2	1.50	3.60	4.50
HMT-ZH1.5-WZ3P	3	3.00	5.10	6.00
HMT-ZH1.5-WZ4P	4	4.50	6.60	7.50
HMT-ZH1.5-WZ5P	5	6.00	8.10	9.00
HMT-ZH1.5-WZ6P	6	7.50	9.60	10.50
.....				
HMT-ZH1.5-WZ16P	16	22.50	24.60	25.50



SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

2	端子 Contact	黄铜	N*1	电镀(锡):整个表面 镀底镍30u~MIN, 再镀锡80u~MIN
1	基座 Wafer	PA66 (UL94V-0)	1	白色
序号	名称	材料	数量	备注

GENERAL TOLERANCES UNLESS SPECIFIED		HMTCONN 深圳市华明通电子有限公司 Shenzhen Huamingtong Electronics Co., Ltd			
X.X ±0.30	X.° ±5°	PART NO.	TITLE:		
.XX ±0.20	X.X° ±1°	HMT-ZH1.5-WZNP	ZH1.5MM 弯针		
.XXX ±0.10	X.XX° ±0.5°	DESIGN: James	CUSTOMER	SIZE	UNITS
MANUFACTURE DWG		CHED: Talen		A4	MM
		APPD: Sophia		SCALE	SHEET
			N:A	1/1	